

DATA SHEET

SKY66112-11: 2.4 GHz Front-End Module for Zigbee Technology Applications /Thread/Bluetooth® Applications

Applications

- In-home appliances
- Smart thermostats
- Internet of Things (IoT) devices
- Smart lighting
- Sensors
- Range extender

Features

- Integrated PA with up to +21 dBm output power
- Integrated LNA (2.7 dB noise figure typical) and bypass path
- Integrated antenna diversity switching for all modes
- Single-ended transmit/receive interface
- Fast switch on/off time: < 800 ns
- Supply range: 1.8 V to 3.6 V
- Sleep mode current: < 1 µA typical
- . No external bias resistor is required
- Small MCM (22-pin, 3.5 mm x 3.0 mm x 1.0 mm) package, NiPdAu-plated (MSL3, 260 °C per JEDEC-J-STD-020)



Skyworks GreenTM products are compliant with all applicable legislation and are halogen-free. For additional information, refer to *Skyworks Definition of Green*TM, document number SQ04-0074.

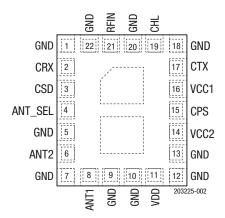


Figure 2. SKY66112-11 Pinout (Top View)

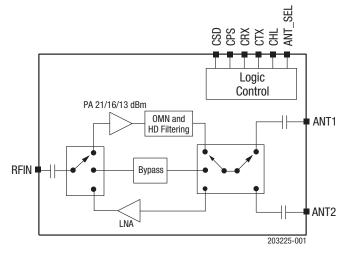


Figure 1. SKY66112-11 Block Diagram

Description

The SKY66112-11 is a high-performance, fully integrated RF front-end module (FEM) designed for Zigbee technology applications, Thread, and Bluetooth® signal applications.

The SKY66112-11 is designed for ease of use and maximum flexibility. The device provides an integrated inter-stage matching and harmonic filter, and digital controls compatible with 1.6 V to 3.6 V CMOS levels.

The RF blocks operate over a wide supply voltage range from 1.8 V to 3.6 V that allows the SKY66112-11 to be used in battery powered applications over a wide spectrum of the battery discharge curve.

A functional block diagram is shown in Figure 1. The SKY66112-11 is provided in a small, 22-pin, 3.5 mm x 3.0 mm Multi-Chip Module (MCM) package. The pin configuration and package are shown in Figure 2. Signal pin assignments and functional pin descriptions are provided in Table 1.

Table 1. SKY66112-11 Signal Descriptions¹

Pin	Name	Description	Pin	Name	Description
1	GND	Ground	12	GND	Ground
2	CRX	Connect to GPIO signal for mode control (see Table 6)	13	GND	Ground
3	CSD	Connect to GPIO signal for mode control (see Table 6)	14	VCC2	PA output stage supply
4	ANT_SEL	Connect to GPIO signal to control antenna switch (see Table 7)	15	CPS	Connect to GPIO signal for mode control (see Table 6)
5	GND	Ground	16	VCC1	PA first stage and LNA supply
6	ANT2	Connect to 50Ω antenna	17	CTX	Connect to GPIO signal for mode control (see Table 6)
7	GND	Ground	18	GND	Ground
8	ANT1	Connect to 50Ω antenna	19	CHL	Connect to GPIO signal for mode control (see Table 6)
9	GND	Ground	20	GND	Ground
10	GND	Ground	21	RFIN	RF input power (transmit/receive port)
11	VDD	Digital logic and RF switch supply	22	GND	Ground

¹ The paddle should be connected to ground.

Electrical and Mechanical Specifications

The absolute maximum ratings of the SKY66112-11 are provided in Table 2. The recommended operating conditions are specified in Table 3, and electrical specifications are provided in Tables 4 and 5.

The state of the SKY66112-11 is determined by the logic provided in Table 6. Table 7 shows the antenna select logic.

Table 2. SKY66112-11 Absolute Maximum Ratings¹

Parameter	Symbol	Minimum	Maximum	Units
Supply voltage	Vcc1 Vcc2 VDD	-0.3 -0.3 -0.3	+3.6 +3.6 +3.6	V V V
Control pin voltages	VCTL	-0.3	+3.6	V
Transmit output power at ANT1 or ANT2 port into 50 Ω load	Pout_tx_max		+22.5	dBm
Transmit input power at RFIN port	PIN_TX_MAX		+5.0	dBm
Receive input power at ANT1 or ANT2 ports ²	PIN_RX_MAX		+15	dBm
Bypass input power at ANT1 or ANT2 ports ²	PIN_BYP_MAX		+20	dBm
Operating temperature	Та	-40	+85	°C
Storage temperature	Тѕтс	-40	+125	°C
Electrostatic discharge:	ESD			
Human Body Model (HBM)			3000	V

Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

CAUTION: Industry-standard ESD handling precautions must be adhered to at all times to avoid damage to this device.

² CW test signal.

Table 3. Recommended Operating Conditions

Parameter	Symbol	Min	Тур	Max	Units
Supply voltage on VCC1 pin	Vcc1	1.7	1.8	3.3	V
Supply voltage on VCC2 pin	Vcc2	0.6	3.0	3.3	V
Supply voltage on VDD pin	VDD	1.8 ¹	3.0	3.3	V
Operating temperature	Та	-40	+25	+85	°C

 $[\]overline{\ }^{1}$ Performance at VDD = 1.8 V will be slightly degraded compared to VDD = 2.5 V and above.

Table 4. SKY66112-11 Electrical Specifications¹

(Vcc1 = 1.8 V, Vcc2 = 3.0 V, VDD = 3.0 V, TA = +25 °C, Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Units
DC Characteristics						
Total supply current	Icc_tx	$Pout = +21 \text{ dBm}^2$ $Pout = +20 \text{ dBm}^2$ $Pout = +16 \text{ dBm}^3$ $Pout = +13 \text{ dBm}^4$		115 90 60 50		mA mA mA mA
Total supply current	Icc_rx			3.5	6	mA
Total supply current	Ісс_вур			5		μА
Sleep supply current	Icc_off	No RF			1	μА
Quiescent current	Іссо_тх	High-power mode ² Low-power mode ³ Low-power mode ⁴		12 8 8		mA mA mA
Logic Characteristics						
Control voltage: High Low	VIH VIL		1.6 0		VDD 0.3	V V
Control current: High Low	lin lir				1.0 1.0	μ Α μ Α
Dual Antenna Switch Characteristics						
Isolation between ANT1 and ANT2 ports	ISO _{ANTSW}			-20		dB
ANT1 to ANT2 switching time	tant1_ant2			400		ns

¹ Performance is guaranteed only under the conditions listed in this table.

 $^{^{2}}$ Vcc1 = 1.8 V, Vcc2 = 3.0 V

³ Vcc₁ = 1.8 V, Vcc₂ = 1.8 V

 $^{^{4}}$ Vcc1 = 1.8 V, Vcc2 = 1.2 V

Table 5. SKY66112-11 Electrical Specifications ¹ (Vcc1 = 1.8 V, Vcc2 = 3.0 V, VDD = 3.0 V, TA = +25 °C, All Unused Ports Terminated with 50 Ω , Unless Otherwise Noted)

Parameter	Parameter Symbol Test Condition		Min	Тур	Max	Units
Transmit Characteristics	<u> </u>		•	•	•	•
Frequency range	f		2400		2483	MHz
Output power at ANT1 or ANT2 port	Роит	Vcc1 = 1.8 V, Vcc2 = 3.0 V, PIN = -1 dBm Vcc1 = 1.8 V, Vcc2 = 3.0 V, PIN = -2 dBm Vcc1 = 1.8 V, Vcc2 = 1.8 V, PIN = -3 dBm Vcc1 = 1.8 V, Vcc2 = 1.2 V, PIN = -3 dBm		+21 +20 +16 +13		dBm dBm dBm dBm
Saturated gain, high power mode	G_SAT			22		dB
Saturated output power variation	ΔРоυт	Across all Zigbee technology channels			1	dBp-p
2 nd and 3 rd harmonics ²	2fo, 3fo	Poυτ = +20.0 dBm, IEEE 802.15.4 source			-42	dBm/MHz
Input return loss	S11			-12		dB
Turn-on time ²	trise	From 50% of CTX edge to 90% of final RF output power		800		ns
Turn-off time ²	t FALL	From 50% of CTX edge to 10% of final RF output power		800		ns
Stability ²	STAB	CW, Pin = 0 dBm, 0.1 GHz to 20 GHz, load VSWR = 6:1	All non-harm	onically related	I outputs < -42	dBm/MHz
Ruggedness ²	RUG	CW, Pin = 0 dBm, load VSWR = 10:1	No permanent damage			
Receive Characteristics						
Frequency range	f		2400		2483	MHz
Receive gain	RX_gain			11		dB
Receive noise figure	NF			2.7		dB
Third order input intercept point	IIP3			0		dBm
1 dB input compression point	IP1dB		-14	-8		dBm
Input return loss	S11	ANT1 or ANT2 ports		-10		dB
Output return loss	S22			-12		dB
Turn-on time ²	trise	From 50% of CRX edge to 90% of final RF output power		800		ns
Turn-off time ²	t FALL	From 50% of CRX edge to 10% of final RF output power		800		ns
Bypass Characteristics						
Frequency range	f		2400		2483	MHz
Bypass gain	BYP_GAIN			-2		dB
Input return loss	S11			-15		dB
Output return loss	S22			-20		dB

¹ Performance is guaranteed only under the conditions listed in this table.

 $^{^{\}mbox{\scriptsize 2}}$ Not tested in production. Fully characterized and guaranteed by design.

Table 6. SKY66112-11 Mode Control Logic¹

(VCC1 = 1.8 V, VCC2 = 3.0 V, VDD = 3.0 V, TA = +25 °C)

Mode	Description	CSD (Pin 3)	CPS (Pin 15)	CRX (Pin 2)	CTX (Pin 17)	CHL (Pin 19)
0	All off (sleep mode) ¹	0	X	X	X	X
1	Receive LNA mode	1	0	1	0	X
2	Transmit high-power mode	1	0	Х	1	1
3	Transmit low-power mode	1	0	X	1	0
4	Receive bypass mode	1	1	1	0	Х
5	Transmit bypass mode	1	1	X	1	Х
6	All off (sleep mode)	1	Х	0	0	Х

¹ All controls must be at V_{DD} or 0 V to achieve the specified sleep current.

Table 7. SKY66112-11 Antenna Select Logic

(VCC1 = 1.8 V, VCC2 = 3.0 V, VDD = 3.0 V, TA = +25 °C)

Description	ANT_SEL (Pin 4)
ANT1 port enabled	0
ANT2 port enabled	1

CHL Control Pin

The CHL pin controls the bias of the PA. For high Vcc2 (for example, 3.0 V), high-power mode (CHL = 1) offers superior TX gain at minimal cost in lcc. For Vcc2 \leq 2.0 V, low-power mode (CHL = 0) offers significant lcc savings.

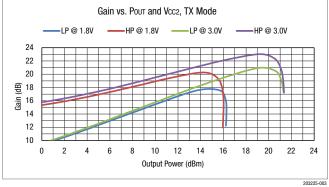


Figure 3. Effect of CHL on Gain (Vcc1 = 1.8 V, Vdd = 3.0 V, f = 2440 MHz)

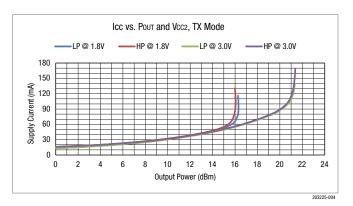


Figure 4. Effect of CHL on Supply Current (Vcc1 = 1.8 V, Vdd = 3.0 V, f = 2440 MHz)

Effect of VDD

VDD supplies the digital logic and the RF switches. It has a nominal level of 3.0 V and typically draws 5 to 20 μ A in TX, RX, and bypass modes. Lowering VDD to 1.8 V reduces TX gain by ~0.25 dB and RX gain by ~0.4 dB, but improves RX P1dB by ~0.25 dB.

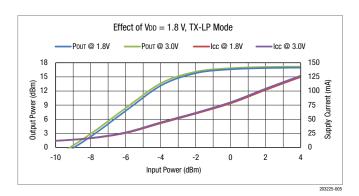


Figure 5. Effect of Lowering Vob (Vcc1 = Vcc2 = 1.8 V, TX-LP mode, f = 2440 MHz)

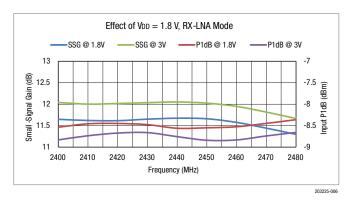


Figure 6. Effect of Lowering VDD (VCC1 = VCC2 = 1.8 V, PIN = -25 dBm, RX-LNA Mode)

Effect of Vcc1

Vcc1 supplies the LNA and the first stage of the PA. It has a nominal level of 1.8 V and typically draws 10 to 20 mA in TX mode and 3.5 mA in RX mode. Raising Vcc1 to 3.0 V increases RX and TX small-signal gain by \sim 0.3 dB and RX P1dB by \sim 1 dB. However, it also increases TX lcc by 1 to 30 mA depending on input power. To avoid high TX lcc, it is recommended to keep PIN at or below -2 dBm.

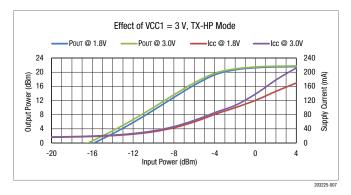


Figure 7. Effect of Raising Vcc1 (Vcc2 = Vdd = 3.0 V, f = 2440 MHz, TX-HP Mode)

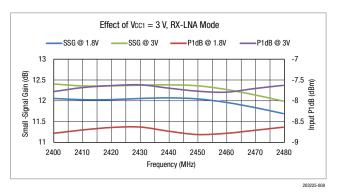


Figure 8. Effect of Raising Vcc1 (Vcc2 = VDD = 3.0 V, PIN = -25 dBm, RX-LNA Mode)

Effect of Vcc2

Vcc2 supplies the output stage of the PA. The level of Vcc2 directly controls the saturated TX output power and this supply draws the majority of the current in TX mode.

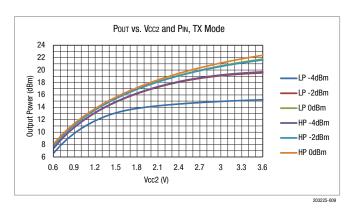


Figure 9. Pout vs. Vcc2 and PiN (Vcc1 = 1.8 V, Vdd = 3.0 V, f = 2440 MHz)

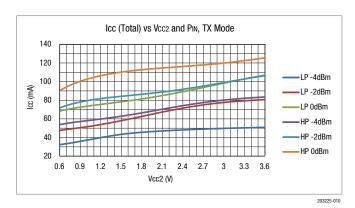
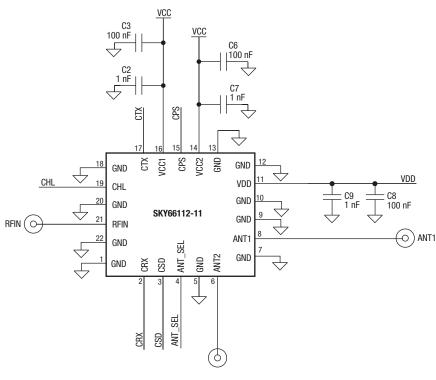


Figure 10. Icc vs. Vcc2 and PiN (Vcc1 = 1.8 V, Vdd = 3.0 V, f = 2440 MHz)

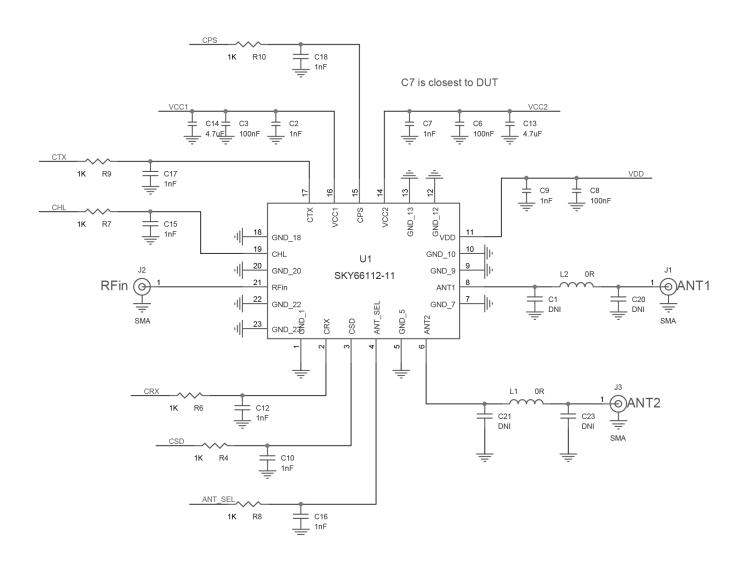
Application Schematic Description

A reference design schematic is provided in Figure 11. An Evaluation Board schematic diagram is shown in Figure 12.



Note: The paddle should be connected to ground.

Figure 11. SKY66112-11 Reference Design Schematic



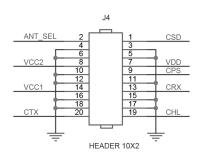


Figure 12. SKY66112-11 Evaluation Board Schematic Diagram

Table 8. Evaluation Board Bill of Materials

Item	Qty	Ref	Value	Manufacturer	Part Number	Package	Description	
1	4	C1, C20, C21, C23	DNI					
2	9	C2, C7, C9, C10, C12, C15, C16, C17, C18	1 nF	Murata	GRM1555C1H102JA01D	0402	Capacitor, ceramic, 1000 pF, 50 V, C0G/NP0	
3	3	C3, C6, C8	100 nF	Murata	GRM155R61H104KE19D	0402	Capacitor, ceramic, 0.1 uF, 50 V X5R	
4	2	C13, C14	4.7 uF	Murata	GRM155R61A475MEAAD	0402	Capacitor, ceramic, 4.7 uF, 10 V X5R	
5	3	J1, J2, J3	SMA, end launch	SPC/Multicmp	615R54-021		.062 edge connector	
6	1	J4	Header 10 x 2	Samtec	TSW-110-07-G-D		Header, vert 20 pin, 2.54 mm	
7	2	L1, L2	0R	Panasonic	ERJ2GE0R00	0402	Resistor, 0 Ω, jumper 1/10 W	
8	1	PCB1	TW22-D355-001	Skyworks	TW22-D355-001		PCB	
9	6	R4, R6, R7, R8, R9, R10	1 kΩ	Panasonic	ERJ2GEJ102	0402	Resistor, 5% 1/10 W	
10	1	U1	SKY66112-11	Skyworks	SKY66112-11	QFN		

Package Dimensions

The typical part marking is shown in Figure 13. The PCB layout footprint for the SKY66112-11 is provided in Figure 14. Package dimensions are shown in Figure 15, and tape and reel dimensions are provided in Figure 16.

Package and Handling Information

Since the device package is sensitive to moisture absorption, it is baked and vacuum packed before shipping. Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SKY66112-11 is rated to Moisture Sensitivity Level 3 (MSL3) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *PCB Design and SMT Assembly/Rework Guidelines for MCM-L Packages*, document number 101752.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.

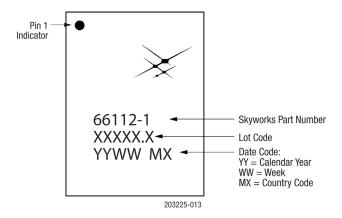
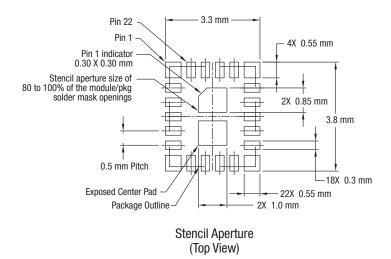
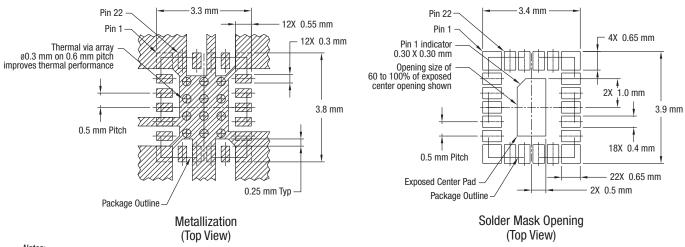


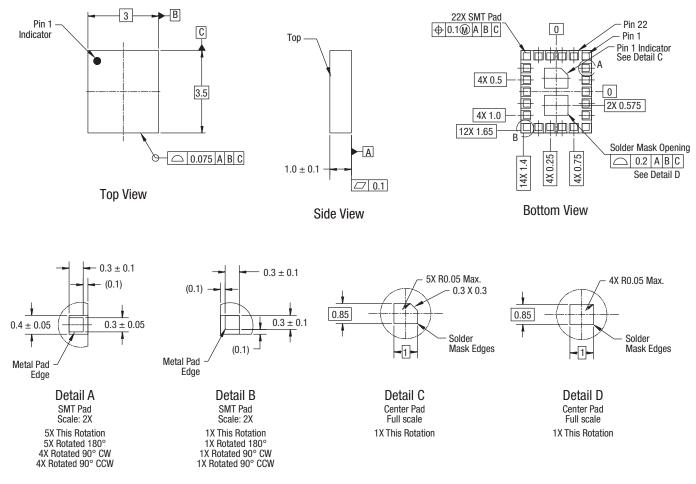
Figure 13. SKY66112-11 Typical Part Marking (Top View)





- 1. All measurements are in millimeters.
- 2. Thermal vias should be resin filled and capped in accordance with IPC-4761 type VII vias. Recommended Cu thickness is 30 to 35 μm .

Figure 14. SKY66112-11 PCB Layout Footprint



Notes:

- 1. Dimensions and tolerances according to ASME Y14.5M-1994.
- 2. All measurements are in millimeters.

Figure 15. SKY66112-11 Package Dimensions

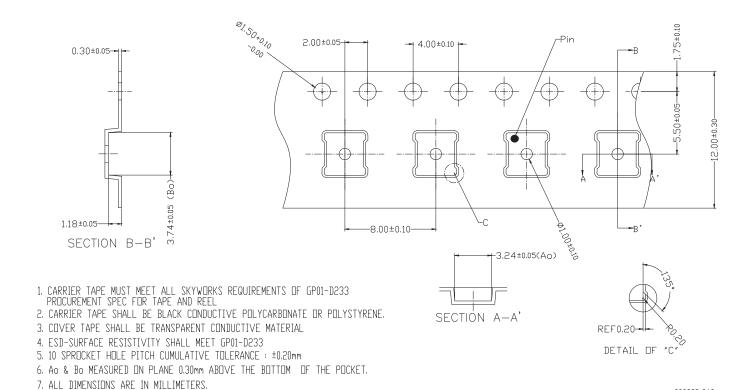


Figure 16. SKY66112-11 Tape and Reel Dimensions

Ordering Information

Part Number	Product Description	Evaluation Board Part Number
SKY66112-11	SKY66112-11: 2.4 GHz front-end module for Zigbee technology applications/Thread/Bluetooth® applications	SKY66112-11EK1

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